Qualification of additional fab sources for devices listed in the attachment below.

None Identified.

This PCN is to notify customers of the qualification of additional wafer fabrication sites in order to assure continuity of supply to our customers. Affected products are listed in the attached table. Full electrical characterization and high reliability testing will be completed on the devices built with the dice from the additional fab sources in order to ensure no change to device functionality or data sheet electrical specifications before shipment to our customers.

See attached parts list.

Unless a Diodes Inc. Sales representative is contacted in writing within 30 days of the posting of this notice, all changes described in this announcement are considered approved.

Mark King  
February 27, 2009

Ed Tang  
February 24, 2009

Francis Tang  
February 24, 2009
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